TOSHIBA TRANSISTOR SILICON-GERMANIUM NPN EPITAXIAL PLANER TYPE

# MT4S200U

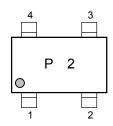
**UHF-SHF** Low Noise Amplifier Application

#### Unit: mm

#### **FEATURES**

- Low Noise Figure :NF=1.7dB (@f=5.8GHz)
- High Gain:|S21e|<sup>2</sup>=9.5dB (@f=5.8GHz)

### Marking



# 

Weight: 0.006 g (typ.)

#### **Absolute Maximum Ratings (Ta = 25°C)**

Characteristics	Symbol	Rating	Unit
Collector-Base voltage	V <sub>CBO</sub>	8	V
Collector-Emitter voltage	V <sub>CEO</sub>	4	V
Emitter-Base voltage	V <sub>EBO</sub>	1.2	V
Collector-Current	IC	35	mA
Base-Current	I <sub>B</sub>	5	mA
Collector Power dissipation	Pc	100	mW
Collector Power dissipation	P <sub>C(Note 1)</sub>	140	mW
Junction temperature	Tj	150	°C
Storage temperature Range	T <sub>stg</sub>	-55~150	°C

Note: Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings.

Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/"Derating Concept and Methods") and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

Note 1: Ta=25degC (When mounted on a 1.6mm(t) glass epoxy PCB)

## **Microwave Characteristics (Ta = 25°C)**

Characteristics	Symbol	Test Condition	Min	Тур.	Max	Unit
Transition Frequency	f <sub>T</sub>	V <sub>CE</sub> =3V, I <sub>C</sub> =15mA	_	30	_	GHz
Insertion Gain	S21e  <sup>2</sup> (1)	V <sub>CE</sub> =3V, I <sub>C</sub> =15mA,f=2GHz	15.0	17.5	_	dB
	S21e  <sup>2</sup> (2)	V <sub>CE</sub> =3V, I <sub>C</sub> =15mA, f=5.8GHz	_	9.5	_	dB
Noise Figure –	NF(1)	V <sub>CE</sub> =3V, I <sub>C</sub> =5mA, f=2GHz	_	0.75	1.0	dB
	NF(2)	V <sub>CE</sub> =3V, I <sub>C</sub> =5mA, f=5.8GHz	_	1.7	_	dB

## **Electrical Characteristics (Ta = 25°C)**

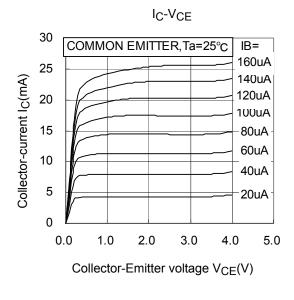
Characteristics	Symbol	Test Condition	Min	Тур.	Max	Unit
Collector Cut-off Current	I <sub>CBO</sub>	V <sub>CB</sub> =8V, I <sub>E</sub> =0	_	_	1	μΑ
Emitter Cut-off Current	I <sub>EBO</sub>	V <sub>EB</sub> =1V, I <sub>C</sub> =0	_	_	1	μΑ
DC Current Gain	hFE	V <sub>CE</sub> =3V, I <sub>C</sub> =15mA	100	_	260	-
Output Capacitance	C <sub>ob</sub>	V <sub>CB</sub> =3V, I <sub>E</sub> =0, f=1MHz	_	0.25	0.5	pF
Reverse Transfer Capacitance	C <sub>re</sub>	V <sub>CB</sub> =3V, I <sub>E</sub> =0, f=1MHz (Note 1)	_	0.074	0.18	pF

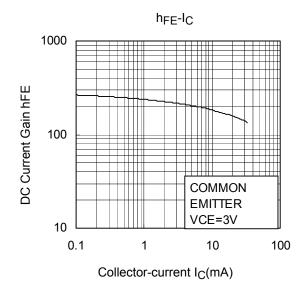
**Note 1:** Cre is measured by 3 terminal method with capacitance bridge.

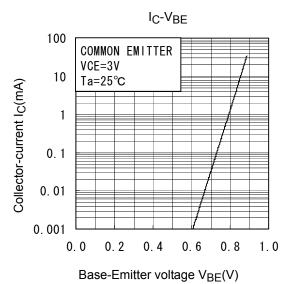
#### Caution:

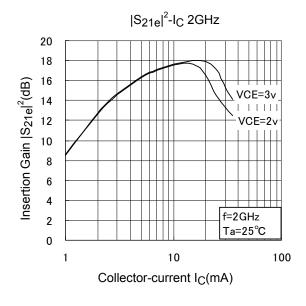
This device is sensitive to electrostatic discharge due to applied the high frequency transistor process of fT=60GHz class is used for this product.

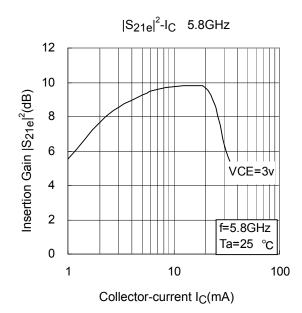
Please make enough tool and equipment earthed when you handle.

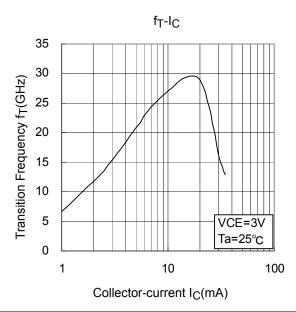


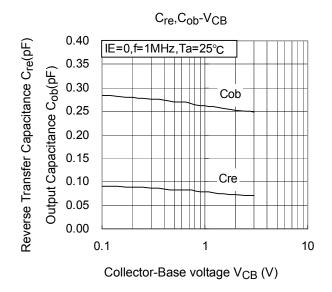


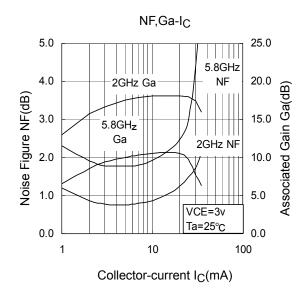


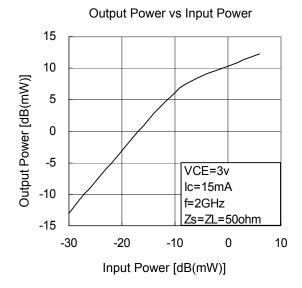


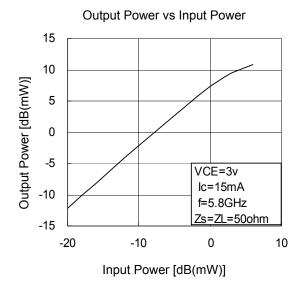


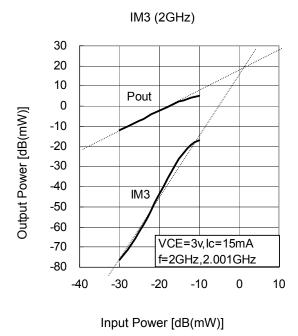


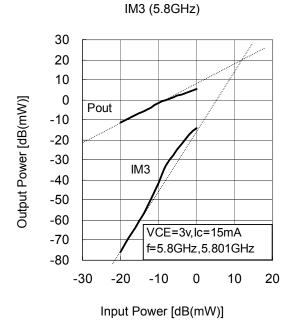












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20070701-EN GENERAL

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